

ECELCAB5VBH

Ultra-low Capacitance Bidirectional Micro Packaged TVS Diodes for ESD Protection

The ECELCAB5VBH is designed with ECORE Punch-Through process TVS technology to protect voltage sensitive components from ESD. Excellent clamping capability, low leakage, and fast response time provide best in class protection on designs that are exposed to ESD. Because of its small size, it is suited for use in cellular phones, MP3 players, digital cameras and many other portable applications where board space comes at a premium. Also because of its low capacitance, it is suited for use in high frequency designs such as USB 2.0 high speed, VGA, DVI and other high speed line applications.

It has been specifically designed to protect sensitive components which are connected to data and transmission lines from overvoltage caused by ESD(electrostatic discharge), and EFT (electrical fast transients).

Features

- Stand-off Voltage: 5.0 V
- Low capacitance (<0.9pF) for high-speed interfaces
- Replacement for MLV (0402)
- Protects I/O Port
- Low Clamping Voltage
- Low Leakage
- Low Capacitance
- Response Time is < 1 ns
- Meets MSL 1 Requirements
- ROHS compliant
- Solid-state Punch-Through TVS Process technology

Main applications

- High Speed Line: USB1.0/2.0, VGA, DVI,
- Serial and Parallel Ports
- Notebooks, Desktops, Servers
- Projection TV
- Cellular handsets and accessories
- Portable instrumentation
- Peripherals

Protection solution to meet

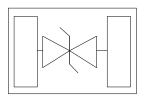
■ IEC61000-4-2 (ESD) ± 15 kV (air), ± 8 kV (contact)

Ordering Information

Device	Marking	Qty per Reel	Reel Size
ECELCAB5VBH	N	5000/10000	7 Inch



DFN1006





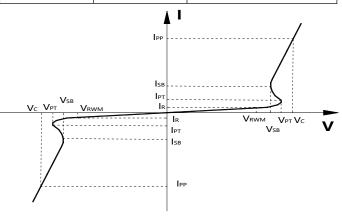
Maximum ratings (Tamb=25℃ Unless Otherwise Specified)					
Parameter	Symbol	Value	Unit		
ESD Rating per IEC61000-4-2: Contact		8	1/1/		
Air		15	KV		
Total Power Dissipation on FR-5 Board@ TA = 25° C	P_{D}	150	mW		
Operating Temperature Range	Tı	- 55 ∼ 150	$^{\circ}$		
Storage Temperature Range	Tstg	- 55 ∼ 150	$^{\circ}$		
Lead Solder Temperature – Maximum (10 Second Duration)	TL	260	$^{\circ}$		

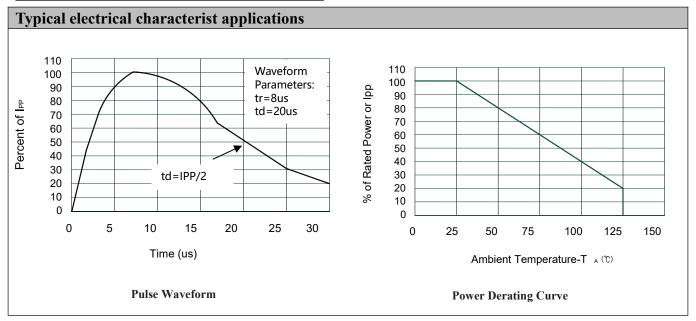
Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

*Other voltages may be available upon request

Other volumes may be available and reduced.							
Electrical characteristics (Tamb=25°C Unless Otherwise Specified)							
	V _{RWM}	I _R @ V _{RWM}	V_{BR}	I_T	$\mathbf{V}_{\mathbf{C}}$	Cj	
Device			(Volts)		@ 1 A	@ $V_R = 0 V, 1 MHz (pF)$	
	(V)	(uA)	Min	(mA)	(V)	Max	
ECELCAB5VBH	5.0	1	5.4	1	12.9	0.9	

Symbol	Parameter	
Vrwm	Working Peak Reverse Voltage	
VPT	Punch-Through Voltage@ IPT	
VsB	Snap-Back Voltage@ I _{SB}	
$V_{\rm C}$	Clamping Voltage @ IPP	
I_T	Test Current	
Irm	Leakage current at VRWM	
Ірр	Peak pulse current	
Co	Off-state Capacitance	
C_{J}	Junction Capacitance	

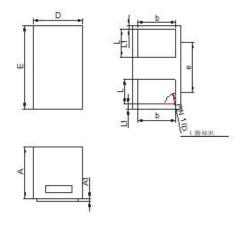






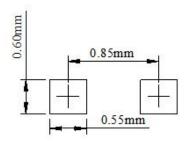
Package Information

DFN-1006

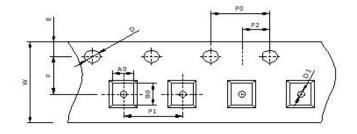


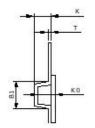
DIM	Millin	neters	Inches		
DIM	Min	Max	Min	Max	
A	0.30	0.50	0.012	0.020	
Al	0.00	0.05	0.000	0.002	
D	0.55	0.65	0.022	0.026	
E	0.95	1.05	0.037	0.041	
b	0.25	0.60	0.010	0.024	
e	0.65TYP		0.026	TYP	
L	0.15	0.35	0.006	0.014	
Ll	0.05	REF	0.002	REF	

Recommended Pad outline



DFN1006 Reel Dim





Package	Chip Size (mm)	Pocket Size B0×A0×K0(mm)	Tape Width	Reel Diameter	Quantity Per Reel	P0	Pl
DFN1006	1.0×0.6×0.50	1.10×0.70×0.60	8mm	178mm(7")	5000/10000	4mm	4/2mm
D0	D1	E	F	K	T	w	
1.5mm	0.5mm	1.75 mm	3.5mm	0.55mm	0.2mm	8mm	

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